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Part Number:	0877581016		- A -
Status:	Active		M H M A
Overview: Description:		Milli-Grid™ Header, Through Hole, Vertical, 10 Circuits, 0.38µm active Plating, Pocket Tray Packaging, Lead-free	
	(- p / (-)		
Documents:			
3D Model		Product Specification PS-87761-100 (PDF)	
Drawing (PDF)		RoHS Certificate of Compliance (PDF)	_ U U U Series
Agency Certifica	ation		image - Reference only
UL		E29179	
General			EU RoHS China RoHS ELV and RoHS
		DOD Lies dars	
Product Family		PCB Headers	Compliant
Series		<u>87758</u>	
Application		Board-to-Board	Contains SVHC: No
Overview		milligrid	Halogen-Free
Product Name		Milli-Grid™	Status Not Halogen-Free
Physical			Need more information on product
Breakaway		Yes	environmental compliance?
Circuits (Loaded)		10	environmental compliance.
Circuits (maximum)		10	Email productcompliance@molex.com
Color - Resin		Black	For a multiple part number RoHS Certificate of
		No	Compliance, <u>click here</u>
First Mate / Last Break Flammability		94V-0	
			Please visit the Contact Us section for any
Glow-Wire Compliant		No	non-product compliance questions.
Guide to Mating Part		No	
Keying to Mating Part		None	
Lock to Mating Part		None	
Mated Height (in)		0.157 In	Secret Parts in this Series
Mated Height (mm)		4.00 mm	Search Parts in this Series
Material - Metal		Phosphor Bronze	<u>87758</u> Series
Material - Plating Ma		Gold	
Material - Plating Termination		Tin	Mates With
Material - Resin		Nylon	<u>79107</u> Milli-Grid [™] Receptacle, Vertical,
Number of Rows		2	Through Hole. <u>79108</u> Milli-Grid [™] Flex-to-
Orientation		Vertical	Board, Vertical Receptacle. Milli-Grid™
PC Tail Length (in)		0.102 ln	Receptacle, Surface Mount. 79109. 87381
PC Tail Length (mm)	2.60 mm	
PCB Locator	,	No	
PCB Retention		None	
PCB Thickness Rec	ommended (in)	0.063 ln	
PCB Thickness Rec	()	1.60 mm	
Packaging Type		Tray	
Pitch - Mating Interface (in)		0.079 ln	
Pitch - Mating Interface (mm)		2.00 mm	
Pitch - Term. Interface (ini)		0.079 In	
		2.00 mm	
Pitch - Term. Interface (mm)			
Plating min: Mating (µin)		15	
Plating min: Mating (µm)		0.38	
Polarized to Mating Part		No	
Polarized to PCB		No	
Shrouded		No	
Stackable		No	

Surface Mount Compatible (SMC) Temperature Range - Operating Termination Interface: Style	Yes -55°C to +105°C Through Hole			
Electrical Current - Maximum per Contact Voltage - Maximum	2A 125V			
Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability Max. Cycles at Max. Process Temperature Process Temperature max. C	3 Wave Capable (TH only) 1 250			
Material Info				
Reference - Drawing Numbers Product Specification Sales Drawing	PS-87761-100 SD-87758-107			

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